TOSHIBA Field Effect Transistor Silicon P Channel MOS Type (U-MOSⅢ)

TPCA8108

High-Side Switching Applications Motor Drive Applications

- · Small footprint due to small and thin package
- Low drain-source ON-resistance: RDS (ON) = 7.7 m Ω (typ.)
- High forward transfer admittance: $|Y_{fs}| = 41S$ (typ.)
- Low leakage current: $I_{DSS} = -10 \,\mu\text{A} \,(\text{max}) \,(V_{DS} = -40 \,\text{V})$
- Enhancement mode: $V_{th} = -1.5$ to -3.0 V ($V_{DS} = -10$ V, $I_{D} = -1$ mA)

Maximum Ratings (Ta = 25°C)

Characte	ristics	Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	-40	V	
Drain-gate voltage (R	$k_{GS} = 20 \text{ k}\Omega$)	V_{DGR}	-40	V	
Gate-source voltage		V_{GSS}	±20	V	
Drain current	DC (Note 1)	I _D	-40	Α	
Diam current	Pulsed (Note 1)	I_{DP}	-120		
Drain power dissipation	on (Tc=25°C)	P_{D}	45	W	
Drain power dissipation	on $(t = 10 s)$ (Note 2a)	P_{D}	2.8	W	
Drain power dissipation	on $(t = 10 s)$ (Note 2b)	P_{D}	1.6	W	
Single pulse avalanch	ne energy (Note 3)	E _{AS}	148	mJ	
Avalanche current		I _{AR}	-40	Α	
Repetitive avalanche	energy c=25°C) (Note 4)	E _{AR}	4.5	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature	range	T _{stg}	-55 to 150	°C	

Note: For (Note 1), (Note 2), (Note 3), (Note 4), please refer to the next page.

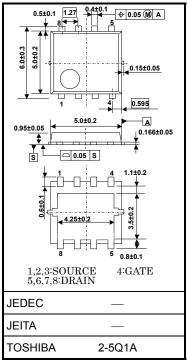
Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even

if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure

Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

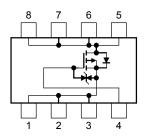
This transistor is an electrostatic-sensitive device. Handle with care.

Unit: mm



Weight: 0.080 g (typ.)

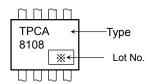
Circuit Configuration



Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case (Tc=25°C)	R _{th (ch-c)}	2.78	°C/W
Thermal resistance, channel to ambient (t = 10 s) (Note 2a)	R _{th (ch-a)}	44.6	°C/W
Thermal resistance, channel to ambient (t = 10 s) (Note 2b)	R _{th (ch-a)}	78.1	°C/W

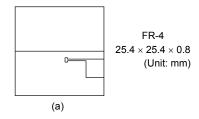
Marking (Note 5)

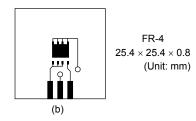


Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2:

- (a) Device mounted on a glass-epoxy board (a)
- (b) Device mounted on a glass-epoxy board (b)





- Note 3: $V_{DD} = -24~V$, $T_{ch} = 25^{\circ}C$ (initial), L = 0.1~mH, $R_G = 25~\Omega$, $I_{AR} = -40~A$
- Note 4: Repetitive rating: pulse width limited by max channel temperature
- Note 5: on lower left of the marking indicates Pin 1.
 - \times shows lot number. (year of manufacture: last decimal digit of the year of manufacture, month of manufacture: January to December are denoted by letters A to L respectively.)

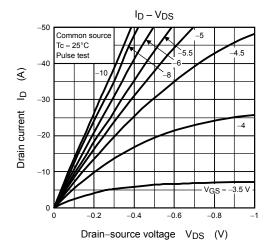


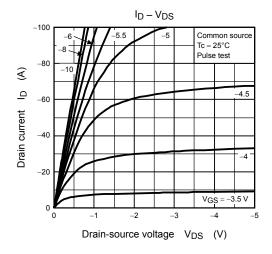
Electrical Characteristics (Ta = 25°C)

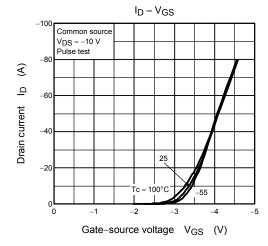
Cha	aracteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cur	rent	I _{GSS}	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±10	μА
Drain cut-OFF cu	ırrent	I _{DSS}	$V_{DS} = -40 \text{ V}, V_{GS} = 0 \text{ V}$		_	-10	μА
Drain source bro	akdown voltago	V (BR) DSS	$I_D = -10 \text{ mA}, V_{GS} = 0 \text{ V}$	-40	_	_	V
Dialii-source bre	akuowii voitage	V (BR) DSX	$I_D = -10 \text{ mA}, V_{GS} = 20 \text{ V}$	-20	_	_	v
Gate threshold vo	oltage	V _{th}	$V_{DS} = -10 \text{ V}, I_{D} = -1 \text{ mA}$	-1.5	_	-3.0	V
Drain-source ON	-resistance	R _{DS} (ON)	$V_{GS} = -10 \text{ V}, I_D = -20 \text{ A}$	_	7.7	9.5	mΩ
Forward transfer	admittance	Y _{fs}	$V_{DS} = -10 \text{ V}, I_D = -20 \text{ A}$	21	41	_	S
Input capacitance	e	C _{iss}			4820	_	
Input capacitance Reverse transfer capacitance Output capacitance		C _{rss}	V _{DS} = -10 V, V _{GS} = 0 V, f = 1 MHz		570	_	pF
Reverse transfer capacitance		Coss			750	_	
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	Rise time	t _r	Vos ^{0 V} 7	_	12	_	
	Output	_	26	_	nc		
Switching time	Fall time	t _f	7.7.7 W W W W W W W W W W W W W W W W W	_	— —3.0 7.7 9.5 41 — 4820 — 570 — 750 — 12 —	ns	
	Turn-OFF time	t _{off}	$V_{DD} \approx -20 \text{ V}$ Duty \leq 1%, $t_W = 10 \mu\text{s}$	_	141	_	
		Qg					
Gate-source charge 1		Q _{gs1}			22		nC
l		Q _{gd}		_	32		
Gate switch char	ge	Q _{SW}]	_	44	_	

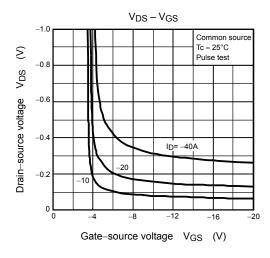
Source-Drain Ratings and Characteristics (Ta = 25°C)

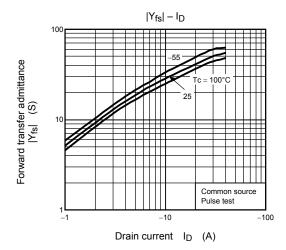
Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit	
Drain reverse current	Pulse	(Note 1)	I _{DRP}	_	_	_	-120	Α
Forward voltage (diode)			V _{DSF}	$I_{DR} = -40 \text{ A}, V_{GS} = 0 \text{ V}$	_	_	1.2	V

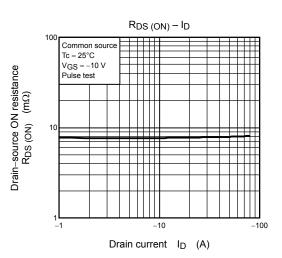


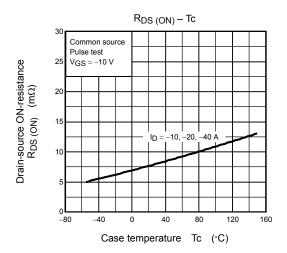


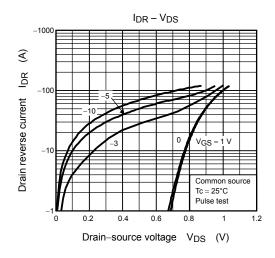


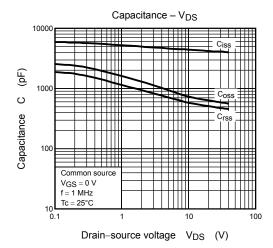


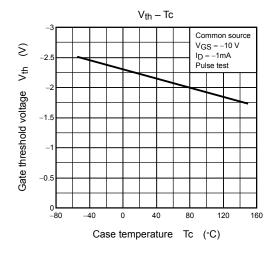


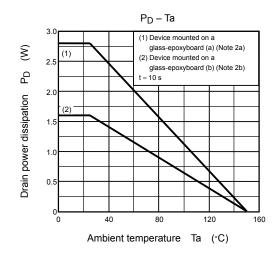


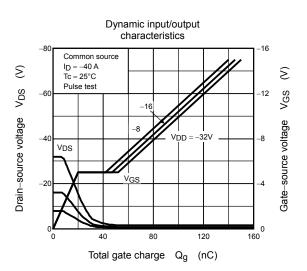


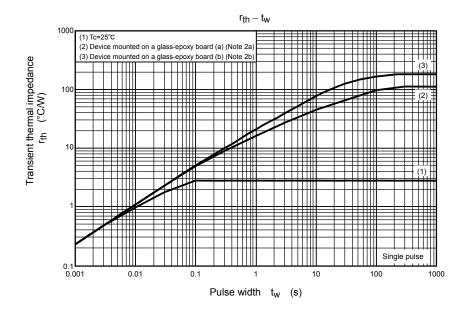


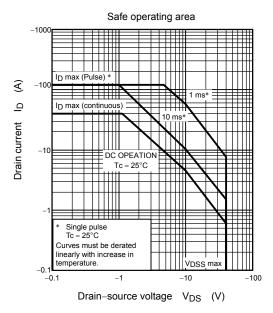


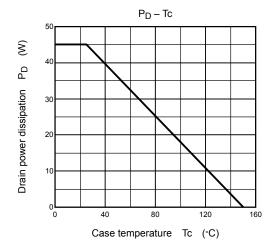












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20070701-EN GENERAL

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